

Upcoming: August 1–2 Intl. Workshop on Processing and Applications of Superconductors, MRS; September 17–20 A First Materials Forum on Future Sustainable Technologies, E-MRS/MRS; October 23–25 2nd Intl. Workshop on Zinc Oxide, MRS

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the May 2002 MRS BULLETIN for July 2002 Calendar entries.

AUGUST 2002

1–2 Intl. Workshop on Processing and Applications of Superconductors, Gatlinburg, TN. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

4–8 14th American Conf. on Crystal Growth and Epitaxy, Seattle, WA. T. Gentile, Conf. Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; fax 805-492-4062; e-mail aacg@latn.org; www.crystalgrowth.org.

4–8 NATO Advanced Research Workshop on Nanostructured Materials and Coatings for Biomedical and Sensor Applications, Kiev, Ukraine. Y. Gogotsi, Drexel Univ., Dept. of Materials Engineering, 3141 Chestnut St., Philadelphia, PA 19104; 215-895-6446; fax 215-895-6760; e-mail gogotsi@drexel.edu; http://nano.materials.drexel.edu/natoarw.html.

4–9 Applied Superconductivity Conf.®, Houston, TX. Centennial Conferences, 4800 Baseline Rd., Ste. A-112, Boulder, CO 80303; 303-499-2299; fax 303-499-2599; e-mail asc@centennialconferences.com; www.ascinc.org.

4–9 Gordon Research Conf. on High-Temperature Materials, Processing, and Diagnostics, Dover, ME. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail besmann@mrl.gov; www.grc.org. **Endorsed.**

4–9 Gordon Research Conf. on Nanostructure Fabrication, Tilton, NH. Gordon Research Conferences, 3071 Rt. 138, Kingston, RI 02881; 401-783-4011; fax 401-783-7644; e-mail grc@grc.org; www.grc.org.

11–14 Conf. of Metallurgical, Metallurgical and Materials Technologies, Montreal, Canada. MetSoc, 3400 de Maisonneuve Blvd. West, Ste. 1210, Montreal, Quebec, H3Z 3B8, Canada; 514-939-2710; fax 514-939-9160; e-mail metsoc@com2002/default.asp.

18–21 Intl. Workshop on Nanostructures for Electronics and Optics, Dresden, Germany. NEOP, Research Ctr. Rosendorf, Inst. of Ion Beam Physics and Materials Research, P.O.B. 51 01 19, Dresden 01314, Germany; fax 49-351-260-3285; e-mail info@NEOP.de; www.NEOP.de.

18–22 ▼ Intl. Symposium on Electrokinetic Phenomena, Krakow, Poland. E. Porebska, Inst. of Catalysis and Surface Chemistry, ul. Niezapominajek 8, 30-239 Krakow, Poland; fax 4812-639-5145; http://kinga.cyf-kr.edu.pl/~ncadamcz/index.html.

18–23 Intl. Conf. on Electrodeposition: Fundamentals and Applications, Banff, Canada. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

19–21 ▼ Atomic Layer Deposition Conf. Seoul, Korea. Hyeongtag Jeon, Div. of Materials Science and Engineering, Seongdong-gu Seoul, 133-791, Korea; fax 82-2-2292-3523; e-mail hjeon@hanyang.ac.kr; www.avs.org/conferences/ald/2002/overview.html.

20–27 23rd Intl. Conf. on Low-Temperature Physics, Hiroshima, Japan. Japan Convention Services, Inc., LT23, Nippon Press Ctr., Bldg., 2-2-1, Uchisaiwaicho, Chiyodaku, Tokyo 100-0011, Japan; 81-3-3508-1214; e-mail lt23@convention.co.jp; www.issp.u-tokyo.ac.jp/lt23.

25–28 8th Electroceramics Conf., Rome, Italy. E. Di Bartolomeo, Dip. Scienze e Tecnologie Chimiche, Univ. di Roma Tor Vergata; Via della Ricerca Scientifica 1, 00133 Roma, Italy; fax 39-06-7259-4328; e-mail electroceram@stc.uniroma2.it; www.uniroma2.it/eventi/electroceramics. **Endorsed.**

25–29 Conf. on Fluid Particle Interactions, Barga, Italy. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

25–30 11th Intl. Conf. on Rapidly Quenched and Metastable Materials, Oxford, UK. P. Schumacher, Dept. of Materials, Oxford Univ., Parks Rd., Oxford OX1 3PH, UK; 44-1234-378862; fax 44-1234-376219; e-mail rq11@materials.ox.ac.uk; www.materials.ox.ac.uk/rq11.

25–30 Conf. on Nanoelectronics and Nanotechnologies, Wolin Island, Poland. WSEAS; www.wseas.org/conferences/2002/miedzdroje/nn/.

26–28 2nd IEEE Conf. on Nanotechnology, Washington, DC. IEEE-Nanotechnology, 2025 M St., Ste. 800, Washington, DC 20036; 202-331-2000; fax 202-331-011; http://ewh.ieee.org/tc/nanotech/nano2002/.

28–31 2nd Intl. Mould & Die Making and Manufacturing Technology Exhibition for Asia, Hong Kong. Business and Industrial Trade Fairs Ltd., Unit 1223, HITEC, 1 Trademart Dr., Kowloon Bay, Hong Kong; 852-2865-2633; fax 852-2866-1770; e-mail enquiry@bitf.com.hk.

SEPTEMBER 2002

1–6 4th European Computational Chemistry Conf., Assisi, Italy. A. Lagana, Dipartimento di Chimica, Via Elce di sotto 8, 06123 Perugia, Italy; 39-755-855-527; fax 39-755-855-606; www.chm.unipg.it/chimgen/mb/cong/EUCO-CC4/index.html.

1–6 13th Intl. Conf. on Ion Beam Modification of Materials, Kobe, Japan. Secretariat-IBMM2002, Y. Yuba, Div. of Advanced Electronics and Optical Science, Graduate School of Engineering Science, Osaka Univ., 1-3 Machikaneyama-cho, Toyonaka, Osaka 560-8531, Japan; 81-6-6850-6301; fax 81-6-6850-6341; e-mail ibmm2002@nano.ee.osaka-u.ac.jp; www.nano.ee.osaka-u.ac.jp/ibmm2002/

4–5 Conf. on 42 Volt Automotive Systems: Exploring the Market and Opportunities in Bringing 42 Volts to Market, Cleveland, OH. B. Santos, Intertech Conferences, 19 Northbrook Office Park, Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail bsantos@intertechusa.com; www.intertechusa.com/42volts.html.

4–6 35th Intl. Symposium on Microelectronics, Denver, CO. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

6–8 ▼ 3rd BioMEMS and Biomedical Nanotech World Conf., Columbus, OH. L. Levine, Cambridge Healthtech Inst., 1037 Chestnut St., Newton Upper Falls, MA; 617-630-1330; fax 617-630-1325; e-mail llevine@healthtech.com; www.chi-biomems.com.

7–9 ▼ BioDevice Interface Science and Technology Workshop, Scottsdale, Arizona. Christine Schnitzer, The American Ceramic Society, PO Box 6136, Westerville, OH 43086-6136, 614-794-5819, cschnitzer@acers.org; www.acers.org/meetings/schedule.asp. **Endorsed.**

7–12 ▼ Conf. on Computational Biophysics: Integrating Theoretical Physics and Biology, San Feliu de Guixols, Spain. European Science Foundation, EURESCO Office, 1 quai Lezay-Marnésia, 67080 Strasbourg cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

7–12 ▼ High-Performance Fibers: EuroConf. on Self-Assembling Fibrous Materials, Bad Herrenalb, Germany. European Science Foundation, EURESCO Office, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7135; fax 33-3-8836-6987; e-mail euresco@esf.org; www.esf.org/euresco.

8–12 6th Intl. Meeting on Magnetic Resonance in Porous Media, Ulm, Germany. www.uni-ulm.de/nmr/mrpm6/early_notification.htm.

9–11 ▼ 7th Gorham Conf. on Compound Semiconductors, Taipei, Taiwan. Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038-5838; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

9–11 ▼ Gorham Conf. on Permanent Magnet Systems and Power Electronics for Motion Control, Cincinnati, OH. Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038-5838; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

9–13 8th Intl. Conf. on Plasma and Surface Engineering, Garmisch-Partenkirchen, Germany. Arbeitskreis Plasmaoberflächentechnologie (PISE Germany), c/o K. Reichel, VDI-Technologiezentrum, Graf-Recke-Str. 84, D-40239 Düsseldorf, Germany; 49-211-6214-567; fax 49-211-6214-484; e-mail akplasma@vdi.de; www.akplasma.org.

10–12 Intl. Conf. on Design and Nature: Comparing Design in Nature with Science and Engineering, Udine, Italy. G. Cossutta, Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail gcossutta@wessex.ac.uk; www.wessex.ac.uk.

10–13 Conf. on Structural Materials Technology: NDE/NDT for Highways and Bridges Topical, Cincinnati, OH. K. Wise, American Society for Nondestructive Testing, 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 614-274-6003; fax 614-274-6899; www.asnt.org.

10–14 Intl. Conf. on Polycrystalline Semiconductors, Nara City, Japan. T. Sameshima, Tokyo Univ. Agriculture and Technology, 2-24-16 Nakamachi, Koganei, Tokyo 184-8588, Japan; phone and fax 81-423-88-7109; e-mail tsamesim@cc.tuat.ac.jp; www.tuat.ac.jp/~polysse02.

11–13 ▼ Albany Symposium on Global Nanotechnology, Lake George, NY. Albany Symposium 2002, 63 State St., Albany, NY 12207; 518-465-8975; fax 518-465-6681; e-mail info@albansymposium.org; www.albansymposium.org.

11–13 Nano and Giga Challenges in Microelectronics: Research Opportunities in Russia, Moscow, Russia. www.AtomicScaleDesign.NET/moscow/.

15–19 ▼ E-MRS Fall Meeting 2002, Cracow, Poland. Professor Ryszard Ciach, e-mail rciach@pk.edu.pl or emrs@pk.edu.pl; www.pk.edu.pl/fm. **E-MRS.**

16–19 2nd Euroasian Conf. on Nuclear Science and Applications, Almaty, Kazakhstan. T. Kvochkin; 7-3272-546-504; e-mail kvochn@inp.kz.

16–20 Intl. Conf. on Shot Peening, Garmisch-Partenkirchen, Germany. P. Schepp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-750; fax 49-69-7917-733; e-mail shot-peening@dgm.de; www.dgm.de/shot-peening.

17–20 A First Materials Forum on Future Sustainable Technologies, Augsburg, Germany. e-mail stritzker@physik.uni-augsburg.de. **E-MRS/MRS.**

18–20 ▼ Integrated Nanosystems Conf., Berkeley, CA. www.asme.org/nano.

22-26 3rd World Congress on Microwave and Radio Frequency Processing, Sydney, Australia. e-mail mrf2002@tourhosts.com.au; www.microwave-rf.org. **Endorsed.**

22-26 Conf. on Advanced Materials and Processes for Gas Turbines, *Copper Mountain, CO.* United Engineering Foundation Conferences, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

22-26 **▼ Intl. Conf. for Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, Moran, WY.** A.W. Thompson, Lawrence Berkeley Lab., M.S. 66-200, Berkeley, CA 94720; 510-486-7021; fax 510-486-4995; e-mail awthompson@lbl.gov; www.ca.sandia.gov/jacksonconference/. **Endorsed.**

22-26 **▼ Intl. Symposium on Bacterial Polyesters, Münster, Germany.** A. Mersmann, Symposium Secretariat, Inst. für Mikrobiologie, Westfälische Wilhelms-Universität, Corrensstraße 3, D-48149 Münster, Germany; 49-251-83-39820; fax 49-251-83-38388; e-mail mersmann@uni-muenster.de; http://mibi1.uni-muenster.de/.

22-27 **▼ 7th Intl. Conf. on Geosynthetics, Nice, French Riviera, France.** Conf. Secretariat, 71CG-Nice2002, B.P. 100, 95873 Bezons Cedex, France; 33-1-3076-4775; fax 33-1-3076-4818; e-mail co@71cg-nice2002.com; www.71cg-nice2002.com.

23-2 **▼ Pan-American Advanced Study Inst. on Science and Technology of Ferroelectric Materials, Rosario, Argentina.** e-mail pasi@anl.gov; www.msdl.anl.gov/pasi/main.html. **Endorsed.**

24-27 3rd World Congress on Emulsions, Lyon, France. CME, 50 Place Marcel Pagnol, 92100 Boulogne-Billancourt, France; 33-147-617-689; fax 33-147-617-465; e-mail alain.lecoroller@wanadoo.fr; www.cme-emulsion.com.

24-28 7th Intl. Conf. on Semi-Solid Processing of Alloys and Composites, Tsukuba, Japan. M. Kiuchi, 7th S2P Secretariat, KILAMETEC, Rm. 703, 5-30-1 Shiba, Minato-ku, Tokyo 108-0014, Japan; fax 81-3-5730-3136; e-mail s2p7@jstp.or.jp; www.s2p7@jstp.or.jp.

25-26 **▼ Conf. on Fuel Cells Science and Technology: Scientific Advances in Fuel Cell Systems, Amsterdam, The Netherlands.** C. Norris, 51 Kestrel Way, Wokingham, Berkshire RG41 3HA, UK; 44-118-377-4696; fax 44-118-377-4696; e-mail claire@eventive.org.uk; www.fuelcelladvances.com.

26-27 10th Intl. Activated Carbon Conf., Pittsburgh, PA. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacslabs.com.

28 **▼ 3rd Dartmouth Molecular Materials Symposium, Hanover, NH.** E. Mahon, Dartmouth Molecular Materials Group, 6128 Burke Lab., Dartmouth College, Hanover, NH 03755; e-mail dmmg@dartmouth.edu; www.dartmouth.edu/~dmmg.

29-2 18th Laser Science Conf., Orlando, FL. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

29-2 IMAPS Nordic Conf., Stockholm, Sweden. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; e-mail info@imapsnordic.org; www.imapsnordic.org.

30-2 Materials Week Congress, and 5th Intl. Trade Fair for Materials Applications, Surface Technology, and Product Engineering, Munich, Germany. E. Richter-Maierhofer, Materialica, Messe München GmbH, 81823 München, Germany; 49-89-949-20650; fax 49-89-949-20659; e-mail richter-maierhofer@messe-muenchen.de; www.materialica.de.

OCTOBER 2002

1-3 Advanced Metallization Conference 2002, San Diego, CA. Continuing Education in Engineering, UC Berkeley Extension, 1995 University Ave., Berkeley, CA 94720-7010; 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal.

1-4 8th Russian Conf. on Gallium Arsenide and III-V Group Related Compounds, Tomsk, Russia. Organizing Committee of <GaAs-2002>, Siberian Physical Technical Inst., pl. Novosobornaya, 1, 634050, Tomsk, Russia; fax 3822-533-034; e-mail brudnyi@ic.tsu.ru; http://phys.tsu.ru/eng/GaAs-2002.

1-4 54th Pacific Coast Regional and ACerS Basic Science Div. Meeting, Seattle, WA. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

4-5 APS Four Corners Section Meeting, Salt Lake City, UT. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

6-10 TMS Fall Meeting, Columbus, OH. TMS Programming Dept., 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail ckobert@tms.org; www.tms.org.

7-10 13th Intl Federation for Heat Treatment and Surface Engineering Congress, and ASM Surface Engineering Congress, Columbus, OH. ASM Intl., 9639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

7-10 ASM Materials Solutions Conf., Columbus, OH. ASM Intl., 9639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

8-11 IMAPS Topical Workshop on Optoelectronics Packaging and Micro-Optoelectromechanical Systems, Bethlehem, PA. Intl. Microelectronics and Packaging Society, 611 2nd St. N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

10-12 APS Texas Section Meeting, Brownsville, TX. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

11-12 APS New York Section Fall Meeting, Syracuse, NY. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

13-16 17th Natl. Educators' Workshop, San Jose, CA. J. Jacobs, School of Science and Technology, Norfolk State Univ., 700 Park Ave., Norfolk, VA 23504-8060; 757-823-8109; fax 757-823-8215; e-mail dplacaire@nsu.edu; http://MST-Online.nsu.edu/new.

13-16 ACerS Glass and Optical Materials Div. Meeting, Pittsburgh, PA. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 619-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

14-17 21st Intl. Congress on Applications of Lasers and Electro-Optics, Scottsdale, AZ. B. Cohen, Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.icaloe.org.

14-18 13th Intl. Conf. on Ternary and Multinary Compounds, Paris, France. D. Lincot, Lab. d'Electrochimie et de Chimie Analytique (CNRS UMR 7575), Ecole Nationale Supérieure de Chimie de Paris, France. 33-155-426-377; fax 33-144-276-750; e-mail lincot@ext.jussieu.fr; www.enscp.jussieu.fr/ICTMC13.

15-17 **▼ Conf. on Damage and Fracture Mechanics, Maui, HI.** G. Cossutta, Damage 2002, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail gcossutta@wessex.ac.uk; www.wessex.ac.uk/conferences/2002/damage02/index.html.

15-18 55th Gaseous Electronics Conf., Minneapolis, MN. e-mail gec@me.umn.edu; www.me.umn.edu/gec.

15-18 **▼ China Magnetic Materials Conf., Beijing, China.** Intertech, 19 Northbrook Dr., Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail info@intertechusa.com; www.intertechusa.com.

16-18 7th Spanish Natl. Materials Conf., Madrid, Spain. O. Sanz, Sociedad Espanola de Ceramica y Vidrio; 34-918-711-800; fax 34-918-700-500; www.secv.es/madridmaterials2002.

16-18 ACerS Refractory Ceramics Division and Pittsburgh Section Fall Meeting, Pittsburgh, PA. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

17-18 9th Sampling, On-Site Analysis, and Sample Preparation Conf., Pittsburgh, PA. Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 724-457-6576; e-mail HNPacs@aol.com; www.pacslabs.com.

18-19 APS Ohio Section Fall Meeting, Columbus, OH. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

20-25 202nd Meeting of the Electrochemical Society, Salt Lake City, UT. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

21-23 **▼ Conf. on Light Emitting Diodes, San Diego, CA.** P. Kinzer, Conf. Director, Intertech Corp., 19 Northbrook Office Park, Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail pkinzer@intertechusa.com; www.intertechusa.com.

21-24 8th Symposium on Temperature: Its Measurement and Control in Science and Industry, Chicago, IL. D.N. Dunkley, 8th Symposium on Temperature, ISA, P.O. Box 12277, 67 Alexander Dr., Research Triangle, NC 12277; e-mail ddunkley@isa.org.

21-24 **▼ IEEE Intl. Integrated Reliability Workshop, S. Lake Tahoe, CA.** G. Bersuker, Technical Program Chair, Intl. SEMATECH, 2706 Montopolis Dr., Austin, TX 78741-6499; 512-356-7045; fax 512-356-7640; e-mail gennadi.bersuker@sematech.org; www.irps.org/irw/.

23-25 **▼ 2nd Intl. Workshop on Zinc Oxide, Dayton, OH.** Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

24-26 2nd Intl. Conf. on Shaping of Advanced Ceramics, Ghent, Belgium. 32-14-335607; e-mail greet.meyen@vito.be.

27-29 **▼ Intl. Conf. on High-Power Electron Beam Technology, Hilton Head, SC.** S.W. Schulz, Surface Solutions, 120 Post Rd., Enfield, CT 06082-5690; 860-745-8462; fax 860-745-8459; e-mail swschulz@surface-sol.com; www.ebeam.org.

28-29 Conf. on Geopolymers, Melbourne, Australia. H. Armitage, P.O. Box 2362, Richmond South, Victoria, 3121 Australia; fax 61-3-9855-0853; e-mail helen@geopolymer2002.com; www.geopolymer2002.com.

29-3 ABET Annual Meeting, Pittsburgh, PA. 2002 ABET Annual Meeting, 11 Market Place, Ste. 1050, Baltimore, MD 21202-4012; www.abet.org.

30-2 APS Southeast Section Meeting, Auburn, AL. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

NOVEMBER 2002

3-7 28th Intl. Symposium for Testing and Failure Analysis, Phoenix, AZ. ASM Intl., 939639 Kinsman Rd., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org.

4-7 34th Intl. SAMPE Technical Conf., *Baltimore, MD*. Society for the Advancement of Material and Process Engineering, 1161 Parkview Dr., Covina, CA 91724-3748; 626-331-0616; fax 626-332-8929; e-mail daunwhite@aol.com; www.sampe.org.

4-8 ▼ ASNT Fall Conf., *San Diego, CA*. J. Heine, Conf. Dept., American Society for Nondestructive Testing, 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 614-274-6003; fax 614-274-6899; e-mail jheine@asnt.org; www.asnt.org/events/conferences/fc02/papers.htm.

4-8 AVS 49th Intl. Symposium, *Denver, CO*. American Vacuum Society Natl. Office, 120 Wall St., 32nd Fl., New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; www.avs.org.

5-7 14th IAS Rolling Conf., 1st IAS Conf. on Uses of Steel, and 4th ISS Argentina Section Meeting, *Buenos Aires, Argentina*. C. Genzano, Inst. Argentino de Siderurgia, Av. Central y Calle 19 Oeste, 2900 San Nicolás, Pcia. de Buenos Aires, Argentina; 54-3461-460803; fax 54-3461-462989; e-mail genzano.ias@cablenet.com.ar; www.cablenet.com.ar/ias/semlaminacion.htm.

6-8 ASTM Intl. Workshop on Galling Test Methods, *Miami Beach, FL*. ASTM Intl., 100 Barr Harbor Dr., West Conshohocken, PA 19428-2959; 610-832-9500; fax 610-832-9555; e-mail service@astm.org; www.astm.org.

10-14 AAPS Annual Meeting, *Toronto, Ontario, Canada*. American Assoc. of Pharmaceutical Scientists, 2107 Wilson Blvd., Ste. 700, Arlington, VA 22201-3046; 703-243-2800; fax 703-243-9532; e-mail meetings@aaps.org; www.aaps.org.

11-13 ▼ 15th Intl. Symposium on Superconductivity, *Yokohama, Japan*. Research and Planning Dept., ISTE, Eishin Kaihatsu Bldg., 34-3, Shinbashi 5-chome, Minato-ku, Tokyo 105-0004, Japan; 81-3-3431-4002; fax 81-3-3431-4044; e-mail iss@istec.or.jp; www.istec.or.jp.

11-15 44th Annual Meeting of the APS Division of Plasma Physics, *Orlando, FL*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

12-16 17th Intl. Conf. on the Application of Accelerators in Research and Industry, *Denton, TX*. J.L. Duggan, Univ. of North Texas, Denton, TX 76203-1427; 940-565-3250; fax 940-565-2227; e-mail jduggan@unt.edu; <http://orgs.unt.edu/CAARI>.

13-15 5th Mechanical Components and Materials Technology Expo Kansai, *Osaka, Japan*. J.A. Go, M-Tech Show Mgmt Office; 81-3-3349-8506; fax 81-3-3345-7929; e-mail go@reedexpo.co.jp; www.reedexpo.co.jp/m-tech.

13-15 Organic Light Emitting Devices Conf., *San Diego, CA*. P. Kinzer, Conf. Director, Intertech Corp., 19 Northbrook Office Park, Portland, ME 04105; 207-781-9604; fax 207-781-2150; e-mail pkinzer@intertechusa.com; www.intertechusa.com.

13-16 ▼ Conf. on Polymers in Medicine and Biology, *Sonoma, CA*. B.D. Ratner, UWEB, Univ. of Washington, Box 351720, Seattle, WA 98195; e-mail ratner@uweb.engr.washington.edu; www.uweb.engr.washington.edu/news/sonoma.html.

18-20 ▼ ASME Intl. and Unicom Research and Development Expo, *New Orleans, LA*. D.W. Babbino, 203-878-2577; e-mail dbabbino@unicom.org; www.rdexpo.com.

18-20 ▼ Gorham Conf. on Advanced Coatings and Surface Systems for Cutting Tools and Wear Parts, *Atlanta, GA*. Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038-5838; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

20-21 Symposium in Memory of Dr. Bernie Miller, *Princeton, NJ*. Course Registrar, TRI/Princeton, 601 Prospect Ave., Princeton, NJ 08540; 609-430-4820; fax 609-683-7149; e-mail info@triprinceton.org; www.triprinceton.org/miller.

24-26 APS Division of Fluid Dynamics Meeting, *Dallas, TX*. Meetings Dept., American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3286; www.aps.org.

DECEMBER 2002

2-6 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

7-11 EUCHEM Conf. on Molecular Tribology, *Märsta, Sweden*. Molecular Tribology, The Swedish Natl. Committee for Chemistry, Wallingatan 24 3tr, SE-111 24 Stockholm, Sweden; 46-8-411-52-60; fax 46-8-10-66-78; e-mail anna@chemsoc.se; www.chemsoc.se.

15-19 ▼ 5th Engineering Foundation Conf. on Molecular Electronics, *Key West, FL*. United Engineering Foundation Conferences, 27th Floor, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

17-20 ▼ Symposium on Gels, Genes, Grafts, and Giants: Transitioning Biomaterials into the 21st Century, *Maui, HI*. S. Ireton, UWEB, Univ. of Washington, Box 351720, Seattle, WA 98195; e-mail info@uweb.engr.washington.edu.

JANUARY 2003

6-8 2nd North American Perpendicular Magnetic Recording Conf., and 6th Perpendicular Magnetic Recording Conf., *Monterey, CA*. fax 419-791-3337; e-mail info@napmrc.org; www.napmrc.org. **Endorsed.**

19-20 ▼ Conf. of the Society of Plastics Engineers, Additives and Colors Europe, *Antwerp, Belgium*. Conf. Secretariat, SPE European Member Bureau, 44 Bistkapellei, BE-2180 Antwerpen, Belgium; 32-3-541-7755; fax 32-3-541-8425; e-mail spe.europe@pi.be; www.antec.ws.

MARCH 2003

2-6 TMS Annual Meeting, *San Diego, CA*. Programming Dept., The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail ckobert@tms.org.

9-12 ▼ European Workshop on Materials for Advanced Metallization, *Aix-Marseille, France*. MAM2003, Case 151, Faculté des Sciences et Techniques de St. Jérôme, 13397 Marseille Cedex 20, France; 33-491-288-738; fax 33-491-288-775; e-mail mam2003@univ.u-3mrs.fr; www.umr-tecsen.com/mam2003.

11-13 ▼ 6th Intl. Conf. on Computer Methods and Experimental Measurements for Surface Treatment Effects, *Crete, Greece*. Conf. Secretariat, Surface Treatment 2003, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail shobbs@wessex.ac.uk; www.wessex.ac.uk/conferences/2003/surface03/.

12-14 ▼ 6th Intl. Conf. on Computational Methods and Experimental Measurements in Contact Mechanics, *Crete, Greece*. Conf. Secretariat, Contact Mechanics 2003, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail shobbs@wessex.ac.uk; www.wessex.ac.uk/conferences/2003/contact03/.

24-28 ▼ Intl. Conf. on Characterization and Metrology for ULSI Technology, *Austin, TX*. L. Printz; 301-975-2054; fax 301-975-6021; www.eeel.nist.gov/812/conference. **Endorsed.**

31-2 ▼ 2nd Intl. Conf. on Thermal Process Modeling and Computer Simulation, *Nancy, France*. Conf. Secretariat, SF2M, Société Française de Métallurgie et de Matériaux, Les Fontenelles, 1 rue de Craiova, F 92024 Nanterre Cedex, France; 33-1-41-02-03-90; e-mail sfmm@wanadoo.fr.

31-3 13th Intl. Conf. on Microscopy of Semiconducting Materials, *Cambridge, UK*. The Inst. of Physics, 76 Portland Place, London W1B 1NT, UK; 44-207-470-4800; e-mail conferences@iop.org.

APRIL 2003

2-4 ▼ 5th Intl. Conf. on Simulations in Biomedicine, *Ljubljana, Slovenia*. Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

8-10 ▼ 84th AWS Annual Meeting, *Detroit, MI*. D. Gonzalez, AWS Professional Program Coordinator, American Welding Society, 550 N.W. LeJeune Rd., Miami, FL 33126; 305-443-9353; fax 305-443-7559; e-mail dorcas@aws.org; www.aws.org.

21-25 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

27-2 14th European Conf. on Chemical Vapor Deposition, *Paris, France*. M. Swihart, 716-645-2911; fax 716-645-3822; e-mail swihart@eng.buffalo.edu. **Endorsed.**

MAY 2003

11-15 ▼ SAMPE 2003, *Long Beach, CA*. D. Weaver, SAMPE Business Office, P.O. Box 2459, Covina, CA 91722; 626-331-0616; fax 626-332-8929; e-mail dweaveribo@cs.com; www.sampe.org.

KK 25-29 ▼ 9th Intl. Conf. on the Mechanical Behavior of Materials, *Geneva, Switzerland*. Conf. Secretariat, ICM9, P.O. Box 50006, Tel Aviv 61500, Israel; 972-3-514-0014; fax 972-3-514-0077; e-mail icm9@kenes.com; www.kenes.com/icm9.

JUNE 2003

9-13 E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www.emrs.c-strasbourg.fr. **E-MRS.**

23-25 ▼ Device Research Conf., *Salt Lake City, UT*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000, fax 724-776-3770; e-mail mtgserv@tms.org.

25-27 ▼ Electronic Materials Conf., *Salt Lake City, UT*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000, fax 724-776-3770; e-mail mtgserv@tms.org.

29-4 16th Intl. Conf. on Ion Beam Analysis, *Albuquerque, NM*. B. Doyle, Sandia Natl. Laboratories, P.O. Box 5800, Albuquerque, NM 87185; 505-844-7568; fax 505-844-7775; e-mail bldoyle@sandia.gov. **Endorsed.**

JULY 2003

10-14 Thermec 2003 Intl. Conf., *Madrid, Spain*. T. Chandra, Faculty of Engineering, Univ. of Wollongong, Wollongong 2522, Australia; 61-242-213-008; fax 61-242-214-921.

13-18 10th World Conf. on Titanium, *Hamburg, Germany*. P. von der Bey, DGM; fax 49-69-7917-733; www.ti-2003.dgm.de.

14-16 ▼ Intl. Conf. on Fatigue Damage of Materials, *Toronto, Canada*. Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

AUGUST 2003

24-27 5th Intl. Symposium on Hydrometallurgy, *Vancouver, Canada*. C.G. Anderson; 406-496-4794.

31-5 16th Intl. Mass Spectrometry Society Conf., *Edinburgh, Scotland*. A. Upton, Secretary to the 16th IMSC Organizing Committee, Orchard House, 172 High Street Yelling, St. Neots, PE19 6SD, UK; 44-1480-88-0069; fax 44-1480-88-059; e-mail imscEdinburgh@btinternet.com; www.imsc-edinburgh2003.com.

SEPTEMBER 2003

22–26 Cryogenic Engineering Conf., and Intl. Cryogenic Materials Conf., *Anchorage, Alaska*. Centennial Conferences, 801 Main St., Ste. 010, Louisville, CO 80027; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.centennialconferences.com.

NOVEMBER 2003

3–8 3rd Intl. Symposium on Slow Dynamics in Complex Systems, *Sendai, Japan*. M. Tokuyama, Inst. of Fluid Science, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 980-8577, Japan; phone and fax 81-22-217-5327; e-mail tokyuyama@ifs.tohoku.ac.jp; www.ifs.tohoku.ac.jp/slow-dynamics/.

5–7 ▼ Intl. Conf. on Material Characterization, *Santa Fe, NM*. Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

9–12 TMS Fall Meeting, *Chicago, IL*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org.

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